

Memory Module Specifications

R&D | OEM | ODM SSD & DDRAM

ST21D4N12C816G

SemiTank C8 16GB DDR4 2133 SO-DIMM

DESCRIPTION

This document describes DDR4 260 Pin SO-DIMM Non ECC, P/N: ST21D4N12C816G. This Memory Module based on Capacity 16GB, Frequency 2133 Mhz, Latency CL15, Data Transfer Bandwidth 17.000 MB/s. DDR4 260 Pin SO-DIMM Non ECC uses gold contact fingers and used for:

- * Laptop.
- * All in One Computer.
- * Industrial Computer.
- * Mini Computer.

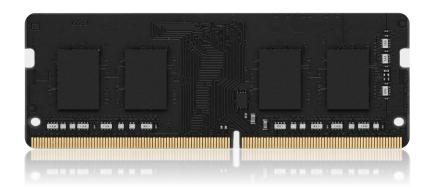
The electrical and mechanical specifications are as follows:

Feature

- Increased Fundamental Frequency, Faster Speeds.
- Unleashed Capacity, Stronger, Multitasking.
- Improved Structural Composition, Greater Efficiency.
- Reduced Working Voltage. Better Energy Efficiency.
- RoHS Compliant and Halogen-Free.

SPECIFICATIONS

Module type	DDR4 260 Pin SO-DIMM Non ECC
Product Dimensions	69.6*30*3.37 mm
Series	C8 Series
Frequency	2133 Mhz
Latency	CL15
Data Transfer Bandwidth	PC3 17000 17.000 MB/s
Capacity	16GB
Capacity Voltage	16GB 1.2V
. ,	
Voltage	1.2V
Voltage Operating Temperature	1.2V 0° C to +70° C



*Note:

- We reserve the right to modify product specifications without prior notice.
- Check "Product Compatibility Inquiry" before purchase for further info.